

Vishay General Semiconductor

Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier

eSMP® Series



SlimSMAW (DO-221AD)

Cathode O Anode

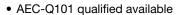
LINKSTO ADDITIONAL RESSOURCES



PRIMARY CHARACTERISTICS				
I _{F(AV)}	3 A			
V_{RRM}	100 V			
I _{FSM}	60 A			
V _F at I _F = 3 A (125 °C)	0.58 V			
T _J max.	175 °C			
Package	SlimSMAW (DO-221AD)			
Circuit configuration	Single			

FEATURES

- Low-profile package
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C



Automotive ordering code: base P/NHM3

Compatible to SOD-128 package case outline

· Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

RoHS COMPLIANT HALOGEN FREE

AUTOMOTIVE GRADE

TYPICAL APPLICATIONS

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial, industrial, and automotive applications.

MECHANICAL DATA

Case: SlimSMAW (DO-221AD)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

H3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	VSS8D3M10	UNIT		
Device marking code		3M10			
Maximum repetitive peak reverse voltage	V _{RRM}	100	V		
Maximum average forward rectified current (fig.1)	I _F ⁽¹⁾	3	A		
	I _F ⁽²⁾	2.1			
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	60	Α		
Operating junction temperature range		-40 to +175	°C		
Storage temperature range	T _{STG}	-55 to +175			

Notes

- (1) Mounted on 30 mm x 30 mm AL PCB pad area
- (2) Free air, mounted on recommended copper pad area
- (3) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_{cl} < 1/R_{B,IA}$



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage	I _F = 1.5 A	T _A = 25 °C	V _F ⁽¹⁾	0.55	1	V
	I _F = 3 A			0.67	0.75	
	I _F = 1.5 A	T _A = 125 °C		0.48	-	
	$I_F = 3 A$			0.58	0.66	
Reverse current	V _R = 70 V	T _A = 25 °C	I _R ⁽²⁾	0.003	ı	
		T _A = 125 °C		0.7	-	mA
	V _R = 100 V	T _A = 25 °C		-	0.2	IIIA
		T _A = 125 °C		1.5	4	
Typical junction capacitance	4.0 V, 1 MHz		CJ	340	1	pF

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise specified)				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Typical thermal resistance	R ₀ JA (1)(2)	120	150	°C/W
Typical thermal resistance	R _{0JM} (3)	12	15	C/VV

Notes

 $^{(1)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$

(2) Thermal resistance junction-to-ambient to follow JEDEC® 51-2A, device mounted on FR4 PCB, 2 oz., standard footprint

(3) Thermal resistance junction-to-mount to follow JEDEC 51-14 transient dual interface test method (TDIM)

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
VSS8D3M10-M3/H	0.033	Н	3500	7" diameter plastic tape and reel	
VSS8D3M10-M3/I	0.033	I	14 000	13" diameter plastic tape and reel	
VSS8D3M10HM3/H (1)	0.033	Н	3500	7" diameter plastic tape and reel	
VSS8D3M10HM3/I (1)	0.033	I	14 000	13" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified



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RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

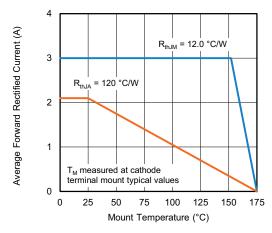


Fig. 1 - Maximum Forward Current Derating Curve

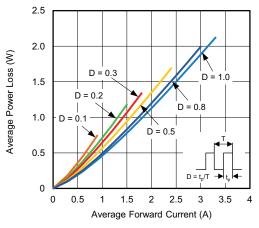


Fig. 2 - Forward Power Loss Characteristics

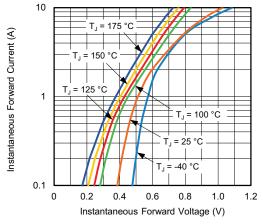


Fig. 3 - Typical Instantaneous Forward Characteristics

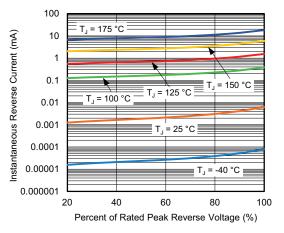


Fig. 4 - Typical Reverse Leakage Characteristics

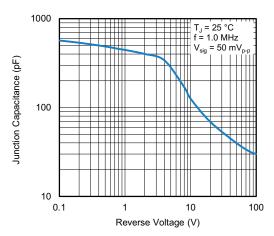


Fig. 5 - Typical Junction Capacitance

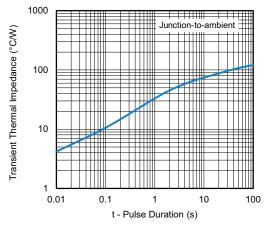


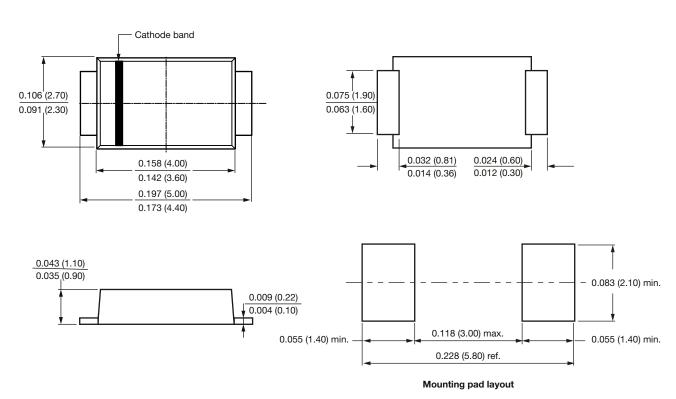
Fig. 6 - Typical Transient Thermal Impedance



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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

SlimSMAW (DO-221AD)





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